



# 深圳市帝国科技有限公司

SHENZHEN DIGUO TECHONLOGY CO., LTD

## 规格书

### Specification

**CUSTOMER** 客户:

**Name** 名称:

声表面谐振器

**Model** 型号:

R433.92M

**Package** 封装:

F11-DIP

审核结果 Audit results	客户签名 SIGNATURE	日期 DATE	备注 REMARK
合格 ACCEPT			
不合格 REJECT			

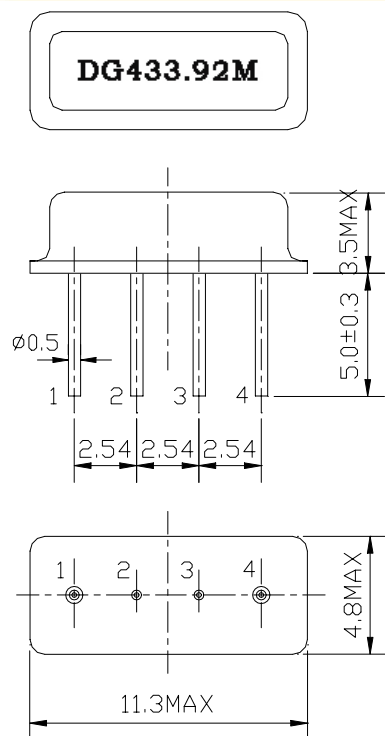
工程: 刘玖武

审核: \_\_\_\_\_

(公章)

## 1. Package Dimension ( F-11 )

Unit: mm



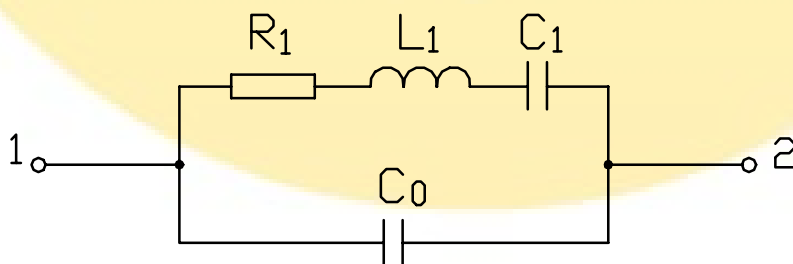
Pin No.	Function
1.	Input
2.	Ground
3.	Ground
4.	Output

## 2. Marking

FI 433.92M

1. Color: Black or Blue
2. D: Manufacture's logo
3. R1: One-port SAW Resonator
4. 433.92: Center Frequency ( MHz)

## 3. Equivalent LC Model

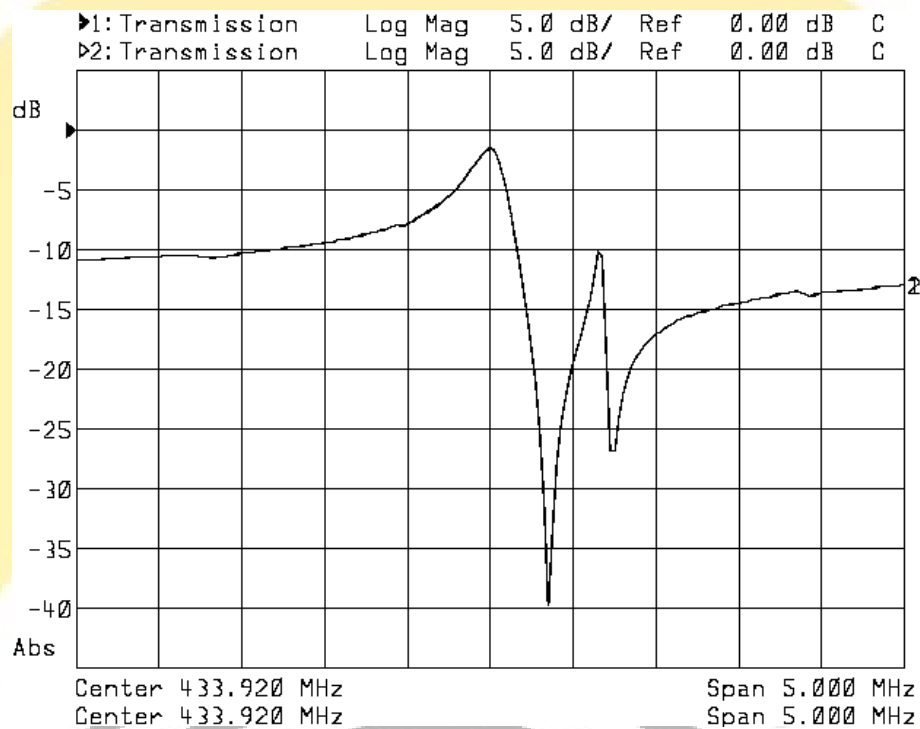


#### 4.1 Maximum Rating

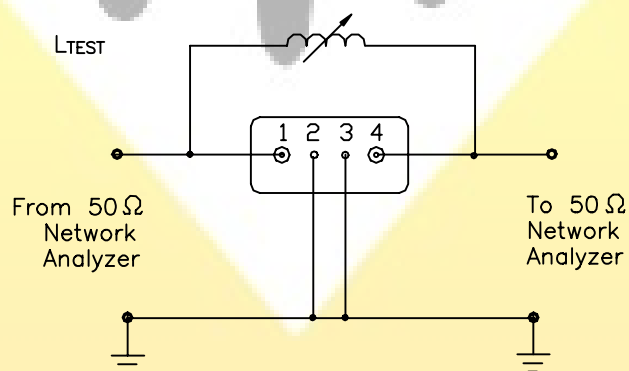
DC Voltage $V_{DC}$	10V
AC Voltage $V_{PP}$	10V (50Hz/60Hz)
Operation Temperature	-40°C to +85°C
Storage Temperature	-45°C to +85°C
RF Power Dissipation	0dBm

Item		Units	Minimum	Typical	Maximum
Center Frequency		MHz	433.845	433.92	433.995
Insertion Loss		dB	—	1.3	2.5
Quality Factor	Unloaded Q	—	—	11,000	—
	50 Ω Loaded Q	—	—	2,000	—
Temperature	Turnover Temperature	°C	—	25	—
Stability	Turnover Frequency	KHz	—	f <sub>o</sub>	—
	Freq. Temp. Coefficient	ppm/°C <sup>2</sup>	—	0.032	—
Frequency Aging		ppm/yr	—	<±10	—
DC Insulation Resistance		M Ω	1.0	—	—
RF Equivalent RLC Model	Motional Resistance R <sub>1</sub>	Ω	—	18	26
	Motional Inductance L <sub>1</sub>	μ H	—	86	—
	Motional Capacitance C <sub>1</sub>	fF	—	1.56	—
	Shunt Static Capacitance C <sub>0</sub>	pF	1.7	2.0	2.3

### 4.3 Frequency Characteristics



### 4.4 Test Circuit



Note: Reference temperature shall be  $25 \pm 2^\circ\text{C}$ . However, the measurement may be carried out at  $5^\circ\text{C}$  to  $35^\circ\text{C}$  unless there is a dispute.

**5.1 Mechanical Shock:** The components shall remain within the electrical specifications after 1000 shocks, acceleration  $392 \text{ m/s}^2$ , duration 6 milliseconds.

**5.3 Terminal Strength:** The components shall remain within the electrical specifications after pulled 2 kgs weight for 10 seconds towards an axis of each terminal.

**5.5 Low Temperature Storage:** The components shall remain within the electrical specifications after being kept at the  $-25^{\circ}\text{C} \pm 2^{\circ}\text{C}$  for 48 hours, then kept at room temperature for 2 hours.

**5.7 Solder-heat Resistance:** The components shall remain within the electrical specifications after dipped in the solder at 260°C for  $10 \pm 1$  seconds, then kept at room temperature for 2 hours. (Terminal must be dipped leaving 1.5 mm from the case).

## 6. Remarks

Static voltage between signal load & ground may cause deterioration & destruction of the component. Please avoid static voltage.

Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning.

Only leads of component may be soldered. Please avoid soldering another part of component.